

MCDN 1,5/11-G1-3,5 RNP26THR - PCB header



1953619

<https://www.phoenixcontact.com/us/products/1953619>

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The figure shows a 10-pos. version with 20 contacts

PCB headers, nominal cross section: 1.5 mm², color: black, nominal current: 8 A, rated voltage (III/2): 160 V, contact surface: Sn, contact connection type: Pin, number of potentials: 22, number of rows: 2, number of positions: 11, number of connections: 22, product range: MCDN 1,5/..-G1-RN-THR, pitch: 3.5 mm, mounting: THR soldering / wave soldering, pin layout: Linear pinning, solder pin [P]: 2.6 mm, number of solder pins per potential: 1, plug-in system: COMBICON FMC 1,5 - MCDN 1,5, Pin connector pattern alignment: Standard, locking: Snap-in locking, mounting method: Engagement nose, type of packaging: packed in cardboard, Article with engagement nose. The pin length is 2.6 mm. User information and design recommendations on Through Hole Reflow Technology can be found at: "Downloads"

Your advantages

- Designed for integration into the SMT soldering process
- Intuitive locking mechanism prevents accidental disconnection
- Conductor connection on several levels enables higher contact density

Commercial data

| | |
|--------------------------------------|---------------|
| Item number | 1953619 |
| Packing unit | 50 pc |
| Minimum order quantity | 50 pc |
| Sales key | AA02 |
| Product key | AABTGA |
| GTIN | 4017918919528 |
| Weight per piece (including packing) | 9.065 g |
| Weight per piece (excluding packing) | 6.889 g |
| Customs tariff number | 85366930 |
| Country of origin | DE |

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Technical data

Product properties

| | |
|---------------------------|--|
| Product type | PCB headers |
| Product family | MCDN 1,5/..-G1-RN-THR |
| Product line | COMBICON Connectors S |
| Type | Component suitable for through hole reflow |
| Number of positions | 11 |
| Pitch | 3.5 mm |
| Number of connections | 22 |
| Number of rows | 2 |
| Number of potentials | 22 |
| Mounting type | Engagement nose |
| Pin layout | Linear pinning |
| Solder pins per potential | 1 |

Electrical properties

Properties

| | |
|-----------------------------|----------------|
| Nominal current I_N | 8 A |
| Nominal voltage U_N | 160 V |
| Contact resistance | 2.1 m Ω |
| Rated voltage (III/3) | 160 V |
| Rated surge voltage (III/3) | 2.5 kV |
| Rated voltage (III/2) | 160 V |
| Rated surge voltage (III/2) | 2.5 kV |
| Rated voltage (II/2) | 250 V |
| Rated surge voltage (II/2) | 2.5 kV |

Mounting

| | |
|---------------|--------------------------------|
| Mounting type | THR soldering / wave soldering |
| Pin layout | Linear pinning |

Processing notes

| | |
|----------------------------------|-----------------------|
| Process | Reflow/wave soldering |
| Moisture Sensitive Level | MSL 1 |
| Classification temperature T_c | 260 °C |
| Solder cycles in the reflow | 3 |

Material specifications

Material data - contact

| | |
|------------------|--|
| Note | WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201 |
| Contact material | Cu alloy |

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| | |
|---|-------------------------|
| Surface characteristics | Tin-plated |
| Metal surface contact area (top layer) | Tin (3 µm - 5 µm Sn) |
| Metal surface contact area (middle layer) | Nickel (1 µm - 3 µm Ni) |
| Metal surface soldering area (top layer) | Tin (3 µm - 5 µm Sn) |
| Metal surface soldering area (middle layer) | Nickel (1 µm - 3 µm Ni) |

Material data - housing

| | |
|--|--------------|
| Color (Housing) | black (9005) |
| Insulating material | LCP |
| Insulating material group | IIIa |
| CTI according to IEC 60112 | 175 |
| Flammability rating according to UL 94 | V0 |

Notes

| | |
|---------------------------------|---|
| Details for soldering processes | Processing using reflow processes in compliance with IEC 60068-2-58 or DIN EN 61760-1 (latest version) Moisture Sensitive Level (MSL) = 1 according to IPC/JEDEC J-STD-020-C |
|---------------------------------|---|

Dimensions

| | |
|-----------------------|--------------|
| Dimensional drawing | |
| Pitch | 3.5 mm |
| Width [w] | 42.2 mm |
| Height [h] | 17.8 mm |
| Length [l] | 13.3 mm |
| Installed height | 15.2 mm |
| Solder pin length [P] | 2.6 mm |
| Pin dimensions | 0.8 x 0.8 mm |

PCB design

| | |
|---------------|---------|
| Pin spacing | 3.50 mm |
| Hole diameter | 1.4 mm |

Mechanical tests

Visual inspection

| | |
|---------------|-----------------------|
| Specification | IEC 60512-1-1:2002-02 |
| Result | Test passed |

Dimension check

| | |
|---------------|-----------------------|
| Specification | IEC 60512-1-2:2002-02 |
| Result | Test passed |

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Resistance of inscriptions

| | |
|---------------|------------------------|
| Specification | IEC 60068-2-70:1995-12 |
| Result | Test passed |

Polarization and coding

| | |
|---------------|------------------------|
| Specification | IEC 60512-13-5:2006-02 |
| Result | Test passed |

Contact holder in insert

| | |
|---|------------------------|
| Specification | IEC 60512-15-1:2008-05 |
| Contact holder in insert Requirements >20 N | Test passed |

Insertion and withdrawal forces

| | |
|-------------------------------------|------------------------|
| Specification | IEC 60512-13-2:2006-02 |
| Result | Test passed |
| No. of cycles | 25 |
| Insertion strength per pos. approx. | 8 N |
| Withdraw strength per pos. approx. | 6 N |

Electrical tests

Thermal test | Test group C

| | |
|----------------------------|-----------------------|
| Specification | IEC 60512-5-1:2002-02 |
| Tested number of positions | 20 |

Insulation resistance

| | |
|--|-----------------------|
| Specification | IEC 60512-3-1:2002-02 |
| Insulation resistance, neighboring positions | > 5 MΩ |

Air clearances and creepage distances |

| | |
|--|---------------------|
| Specification | IEC 60664-1:2007-04 |
| Insulating material group | IIIa |
| Comparative tracking index (IEC 60112) | CTI 175 |
| Rated insulation voltage (III/3) | 160 V |
| Rated surge voltage (III/3) | 2.5 kV |
| minimum clearance value - non-homogenous field (III/3) | 1.5 mm |
| minimum creepage distance (III/3) | 2.5 mm |
| Rated insulation voltage (III/2) | 160 V |
| Rated surge voltage (III/2) | 2.5 kV |
| minimum clearance value - non-homogenous field (III/2) | 1.5 mm |
| minimum creepage distance (III/2) | 1.6 mm |
| Rated insulation voltage (II/2) | 250 V |
| Rated surge voltage (II/2) | 2.5 kV |
| minimum clearance value - non-homogenous field (II/2) | 1.5 mm |
| minimum creepage distance (II/2) | 2.5 mm |

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Environmental and real-life conditions

Durability test

| | |
|--|-----------------------|
| Specification | IEC 60512-9-1:2010-03 |
| Impulse withstand voltage at sea level | 2.95 kV |
| Contact resistance R_1 | 2.1 m Ω |
| Contact resistance R_2 | 2.4 m Ω |
| Insertion/withdrawal cycles | 25 |
| Insulation resistance, neighboring positions | > 5 M Ω |

Climatic test

| | |
|-----------------------------------|---|
| Specification | ISO 6988:1985-02 |
| Corrosive stress | 0.2 dm ³ SO ₂ on 300 dm ³ /40 °C/1 cycle |
| Thermal stress | 100 °C/168 h |
| Power-frequency withstand voltage | 1.39 kV |

Vibration test

| | |
|------------------------|-----------------------------|
| Specification | IEC 60068-2-6:2007-12 |
| Frequency | 10 - 150 - 10 Hz |
| Sweep speed | 1 octave/min |
| Amplitude | 0.35 mm (10 Hz ... 60.1 Hz) |
| Acceleration | 5g (60.1 Hz ... 150 Hz) |
| Test duration per axis | 2.5 h |
| Test directions | X-, Y- and Z-axis |

Ambient conditions

| | |
|---|---|
| Ambient temperature (storage/transport) | -40 °C ... 70 °C |
| Relative humidity (storage/transport) | 30 % ... 70 % |
| Ambient temperature (assembly) | -5 °C ... 100 °C |
| Ambient temperature (operation) | -40 °C ... 100 °C (dependent on the derating curve) |

Packaging specifications

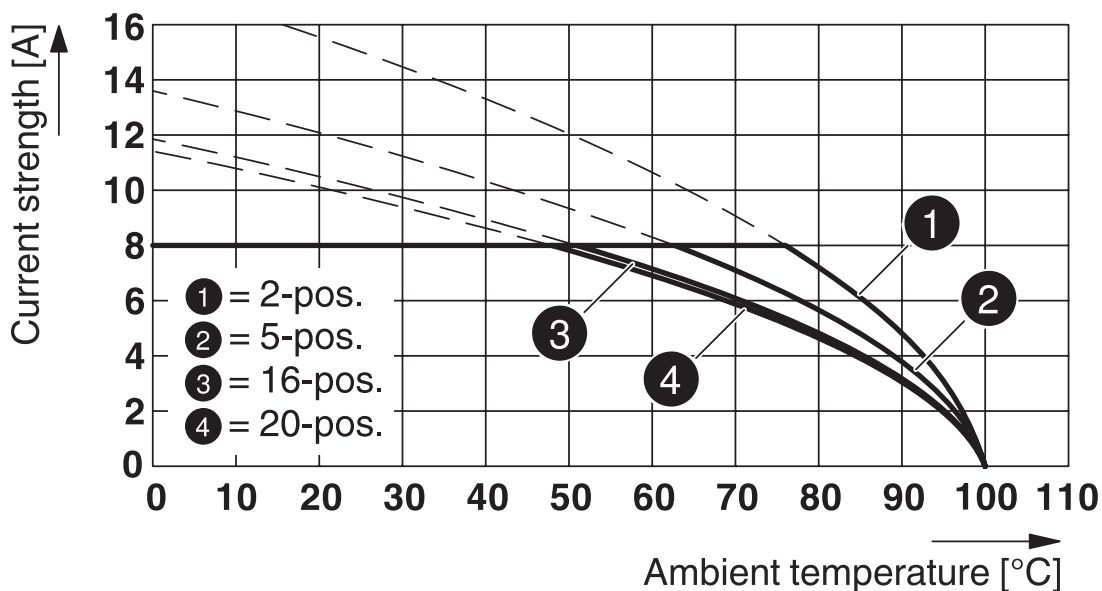
| | |
|-------------------|---------------------|
| Type of packaging | packed in cardboard |
|-------------------|---------------------|

Drawings

Dimensional drawing



Diagram



Type: FMC 1,5/...-ST-3,5-RF with MCDN 1,5/...-G1-3,5 RNP..THR

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Drilling plan/solder pad geometry



*) \leq 8-pos. = 1.3 / $>$ 8-pos. = 1.4

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Approvals

To download certificates, visit the product detail page: <https://www.phoenixcontact.com/us/products/1953619>

|  cULus Recognized Approval ID: E60425-20110128 | | | | |
|---|-----------------------|-----------------------|-------------------|----------------------|
| | Nominal voltage U_N | Nominal current I_N | Cross section AWG | Cross section mm^2 |
| B | 150 V | 8 A | - | - |
| D | 150 V | 8 A | - | - |

|  VDE Zeichengenehmigung Approval ID: 40011723 | | | | |
|--|-----------------------|-----------------------|-------------------|----------------------|
| | Nominal voltage U_N | Nominal current I_N | Cross section AWG | Cross section mm^2 |
| keine | 160 V | 8 A | - | - |

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Classifications

ECLASS

| | |
|-------------|----------|
| ECLASS-13.0 | 27460201 |
| ECLASS-15.0 | 27460201 |

ETIM

| | |
|-----------|----------|
| ETIM 10.0 | EC002637 |
|-----------|----------|

UNSPSC

| | |
|-------------|----------|
| UNSPSC 21.0 | 39121400 |
|-------------|----------|

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Environmental product compliance

EU RoHS

| | |
|---|--------------------|
| Fulfills EU RoHS substance requirements | Yes, No exemptions |
|---|--------------------|

China RoHS

| | |
|--|--|
| Environment friendly use period (EFUP) | EFUP-E |
| | No hazardous substances above the limits |

EU REACH SVHC

| | |
|-------------------------------------|----------------------------|
| REACH candidate substance (CAS No.) | No substance above 0.1 wt% |
|-------------------------------------|----------------------------|

EF3.1 Climate Change

| | |
|---------|---------------|
| CO2e kg | 0.098 kg CO2e |
|---------|---------------|

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